

# MCM'21 AUGUST 02 - 04, 2020 | PRAGUE, CZECH REPUBLIC VIRTUAL CONFERENCE

## 7<sup>TH</sup> WORLD CONGRESS ON MECHANICAL, CHEMICAL, AND MATERIAL ENGINEERING

MCM'21 is composed of 4 conferences, while each conference consists of an individual and separate theme, they share considerable overlap, which prompted the organization of this congress.

The goal of this undertaking is to bring together experts in each of the specialized fields, and at the same time allow for cross pollinations and sharing of ideas from the other closely related research areas. Interested authors, researchers, and industrial experts are invited to register for the conference that best resonates with their technical background. At the same time, attendees are permitted, and even encouraged, to attend talks from co-located conferences.



**Final Extended Paper Submission Deadline: MAY 21, 2021**    **Final Extended Early Bird Registration: JUNE 03, 2021**

**HTFF**  
2021

8<sup>th</sup> International Conference on  
**Heat Transfer and Fluid Flow**

www. [htffconference.com](http://htffconference.com)

**ICMIE**  
2021

10<sup>th</sup> International Conference on  
**Mechanics and  
Industrial Engineering**

www. [icmie.net](http://icmie.net)

**MMME**  
2021

8<sup>th</sup> International Conference on  
**Mining, Material and  
Metallurgical Engineering**

www. [mmmeconference.com](http://mmmeconference.com)

**ICCPE**  
2021

7<sup>th</sup> International Conference on  
**Chemical and Polymer Engineering**

www. [cpeconference.com](http://cpeconference.com)

The proceedings of this congress will be indexed by

**Scopus and Google Scholar.**

### SUBMISSIONS

Submissions in the form of extended abstracts, short papers, and full manuscripts are welcome. All submitted papers will be peer reviewed. All accepted and presented papers will be published in the conference proceedings, under an ISBN reference in a USB drive. The online version of the proceedings will also be published under an ISSN reference and each paper in the proceedings will be assigned unique **DOIs by CrossRef**. The proceedings will be permanently archived in **Portico** (one of the largest community-supported digital archives in the world).

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University of Missouri,  
USA  
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## KEYNOTE SPEAKERS



**Dr. Christos Markides**  
Imperial College, UK



**Dr. Krishnaswamy Nandakumar**  
Louisiana State University, USA



**Dr. Michael Kaufman**  
Colorado School of Mines, USA



**Dr. Perumal Nithiarasu**  
University of Wales, UK



**Dr. Yulong Ding**  
University of Birmingham, UK



**Dr. Jiang Jianwen**  
National University of Singapore (NUS), Singapore



**Dr. Min Xie**  
City University of Hong Kong, China



**Dr. Surendra M. Gupta**  
Northeastern University, USA

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